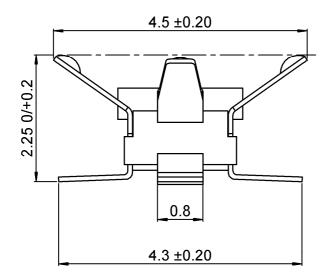
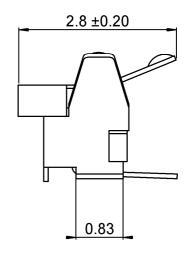
REEL OF 100

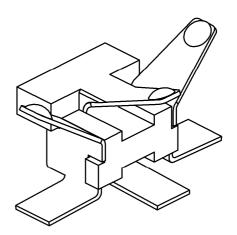
R107.064.070

Series: IMP





>≇∠ Scale 1:1



All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (μm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	BERYLLIUM COPPER BERYLLIUM COPPER BERYLLIUM COPPER POLYETHER ETHERCETONE 30% GF	GOLD 0.5 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2

Issue: 1343 C

In the effort to improve our products, we reserve the right to make changes judged to be



REEL OF 100

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PACKAGING

Standard	Unit	Other
100	'W' option	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

 $\begin{array}{ccc} \text{Impedance} & & \textbf{50} \;\; \Omega \\ \text{Frequency} & & \textbf{0-6} \;\; \text{GHz} \end{array}$

VSWR 1.5 + 0,0000 x F(GHz) Maxi Insertion loss 0.3 $\sqrt{F(GHz)}$ dB Maxi

Insertion loss

RF leakage

- (
NA - F(GHz) dB Maxi

Nalkage grating

Voltage grating

Voltage rating100Veff MaxiDielectric withstanding voltage350Veff miniInsulation resistance3000MΩ mini

ENVIRONMENTAL

Operating temperature -40/+90 ° C

Hermetic seal NA Atm.cm3/s Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

NA N mini
NA N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 10 Cycles mini

Weight **0,0130** g

Issue: 1343 C

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REEL OF 100

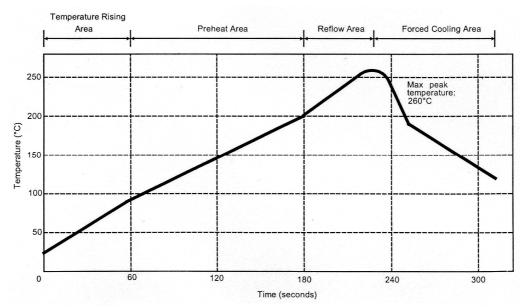
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SOLDER PROCEDURE

- 1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 microns (5.850 microinch). Verify that the edges of the zone are clean.
- Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- This process of soldering has been tested with convection oven. Below please find, the typical profile to use.
- Cleaning of printed circuit boards.
- Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parmeter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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necessary.



REEL OF 100

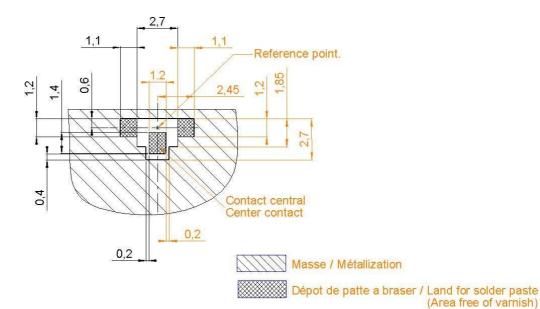
R107.064.070

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IMP SERIES INFORMATION

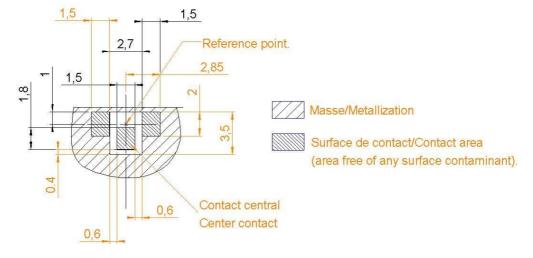
All dimension are in mm

PCB 1



Vias and transmission line inside PCB are not represented. The impedance of the transmission line should be 50 ohms





Vias and transmission line inside PCB are not represented. The impedance of the transmission line should be 50 ohms

RADIAL MISALIGNMENT IN MM: 0.2 IN INCH: .008

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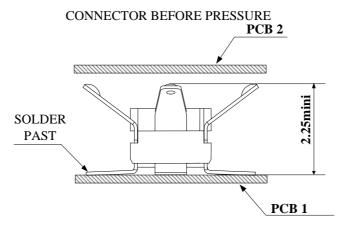


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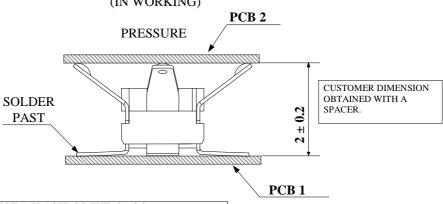
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Series: IMP

IMP-SERIES-INFORMATION



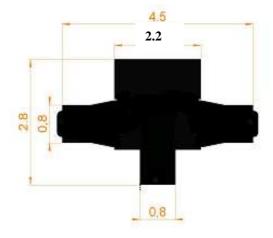
CONNECTOR IN PRESSURE (IN WORKING)



THE CONNECTOR IS NOT A SPACER, SO THE 2 ± 0.2 DIMENSION A MUST BE ENSURED WITH AN ADDED PIECE PART SETTED 10 mm MAX.FAR FROM THE IMP CONNECTOR.

Shadow of IMP receptacle for video camera.

All dimensions are in mm.



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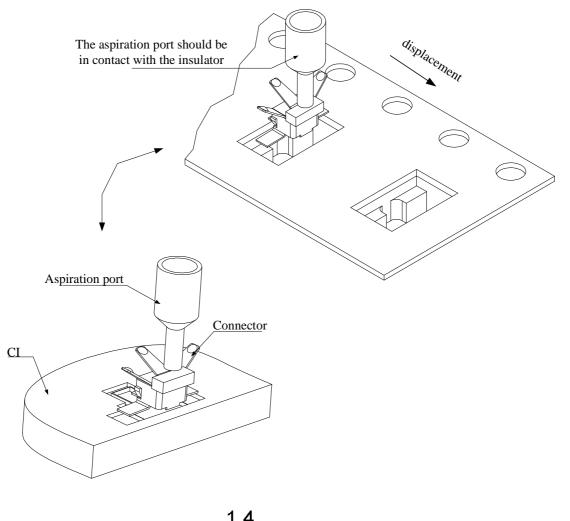


REEL OF 100

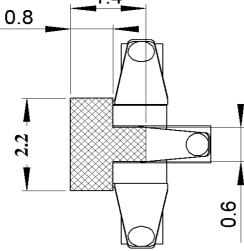
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Aspiration area



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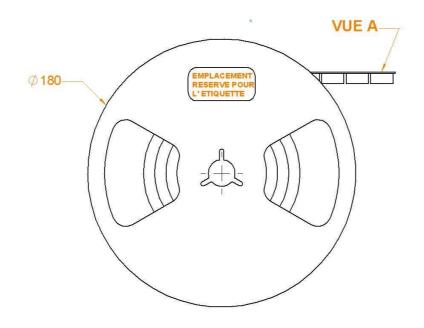


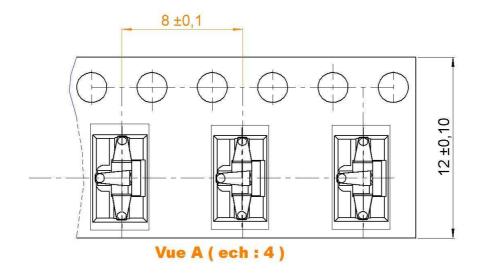
REEL OF 100

R107.064.070

Series: IMP

IMP-SERIES-INFORMATION





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